

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PASSEMAPPLICATION OF

Confirmation No.: 5539

Tomohisa HOSHINO et al.

Group Art Unit: 2825

Appln. No.: 09/835,820

Examiner: LUU, Chuong A

Filed: April 17, 2001

Title: FABRICATION PROCESS OF A SEMICONDUCTOR DEVICE INCLUDING A CVD

PROCESS OF A METAL FILM

April 16, 2002

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TECHNOLOGY CENTER 2800

7/A Hmolt 1/902

AMENDMENT

Hon. Commissioner of Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated January 16, 2002, please amend the above identified application as follows:

IN THE CLAIMS:

Please enter the following amended claims:

2. (Amended) A method as claimed in claim 1, wherein said first reducing gas atmosphere is selected from the group consisting of: silane, ammonia and hydrogen.

4. (Amended) A method as claimed in claim 1, wherein said second reducing gas atmosphere includes hydrogen.

See the attached Appendix for the changes made to effect the above claim(s).